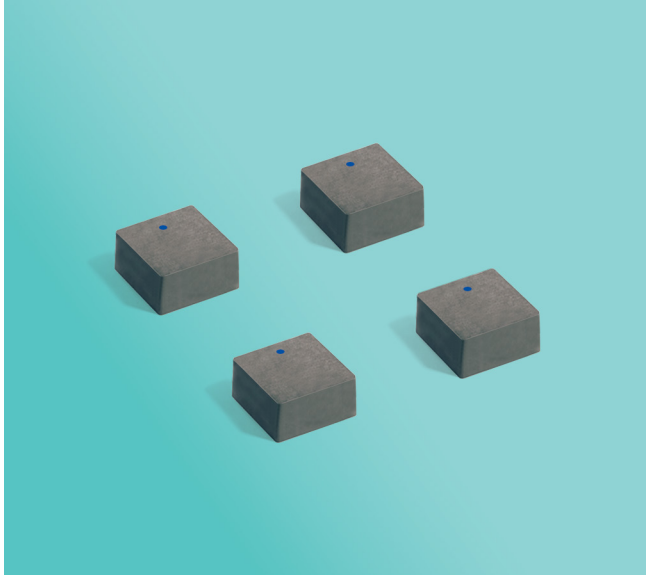


Outgassing Compliant Power Inductors AE486PYA



- High temperature materials allow operation in ambient temperatures up to 155°C
- Passes NASA low outgassing specifications
- Passes vibration testing to 80 G and shock testing to 1000 G
- Tin-lead (Sn-Pb) termination for the best possible board adhesion
- High current and very low DCR
- Soft saturation makes them ideal for VRM/VRD applications.

Core material Composite

Terminations Tin-lead (63/37) over copper.

Weight 0.40 – 0.51 g

Ambient temperature –55°C to +105°C with Irms current,

Maximum part temperature +155°C (ambient + temp rise)

Storage temperature Component: –55°C to +155°C.

Tape and reel packaging: –55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at

+260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 250 per 7" reel

Plastic tape: 16 mm wide, 0.3 mm thick, 8 mm pocket spacing, 5.21 mm pocket depth

Part number ¹	Inductance ² ±20% (µH)	DCR (mOhms) ³		SRF (MHz) ⁴		Isat (A) ⁵	Irms (A) ⁶	
		typ	max	min	typ		20°C rise	40°C rise
AE486PYA161MSZ	0.16	2.15	2.36	146	183	31.0	10.7	16.7
AE486PYA331MSZ	0.33	3.20	3.52	86	108	23.0	10.4	14.4
AE486PYA601MSZ	0.60	4.11	4.52	60	75	17.6	10.2	13.3
AE486PYA801MSZ	0.80	5.14	5.65	50	63	15.1	7.5	9.8
AE486PYA102MSZ	1.0	8.50	9.40	54	68	14.0	6.5	8.3
AE486PYA222MSZ	2.2	13.20	14.50	30	38	9.1	5.4	7.3
AE486PYA332MSZ	3.3	21.20	23.30	22	28	7.1	4.4	6.1
AE486PYA472MSZ	4.7	32.70	36.00	18	23	5.8	3.2	4.4

1. When ordering, please specify **testing** code:

AE486PYA472MSZ

Testing:

Z = Unscreened

H = Group A screening per Coilcraft CP-SA-10001

T = Screening per MIL-STD-981

U = Screening per EEE-INST-002

F = Screening per ESCC 3201

All screening performed to the document's latest revision

Custom screening also available

2. Inductance tested at 100 kHz, 0.1 Vrms using an Agilent/HP 4192A.

3. DCR measured on a micro-ohmmeter.

4. SRF measured using Agilent/HP 4395A or equivalent.

5. DC current at 25°C that causes an inductance drop of 30% (typ) from its value without current.

6. Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.

7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

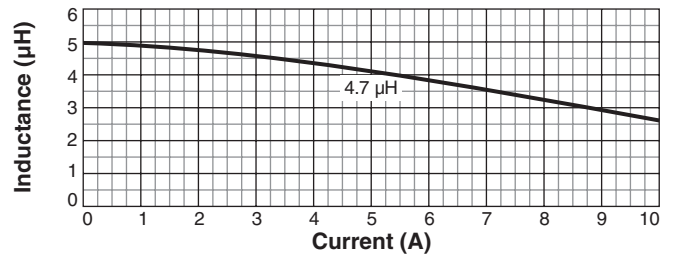
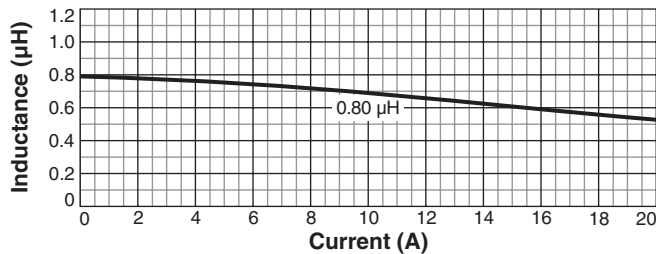
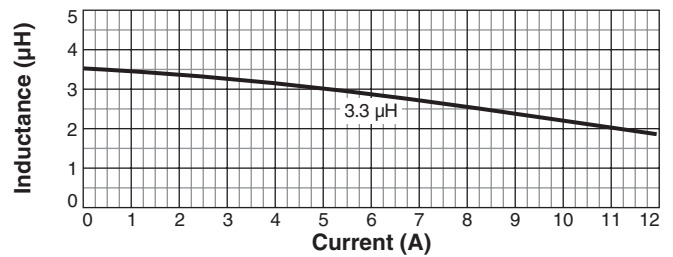
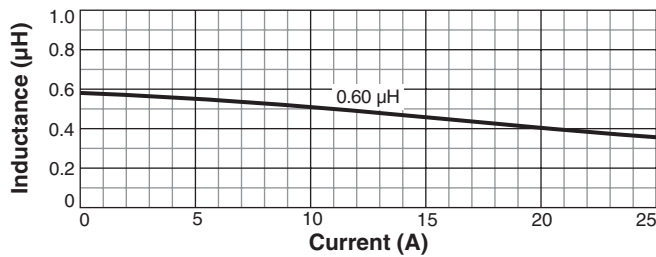
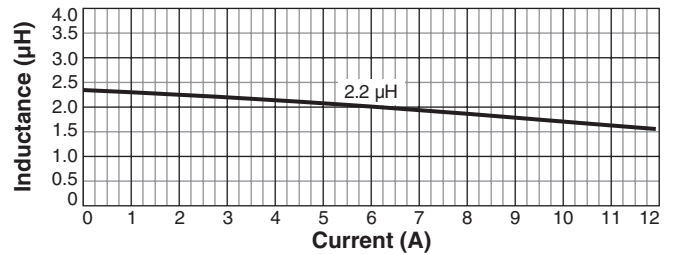
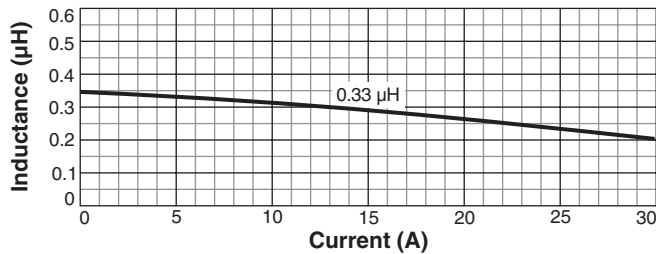
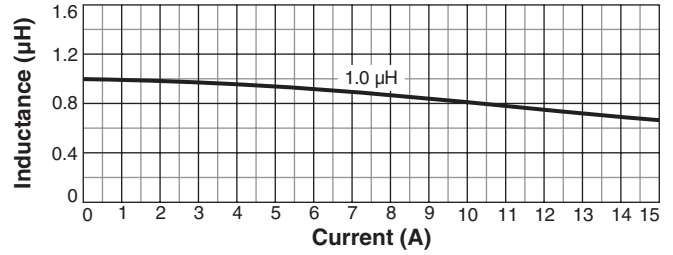
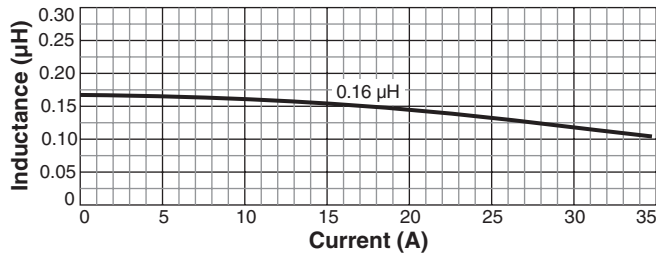
Irms Testing

Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

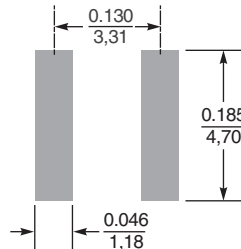
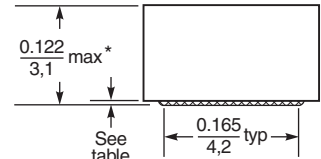
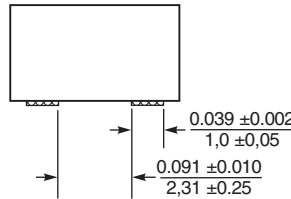
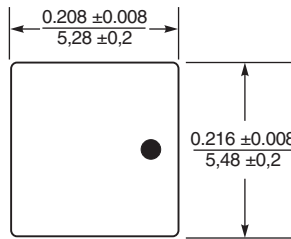
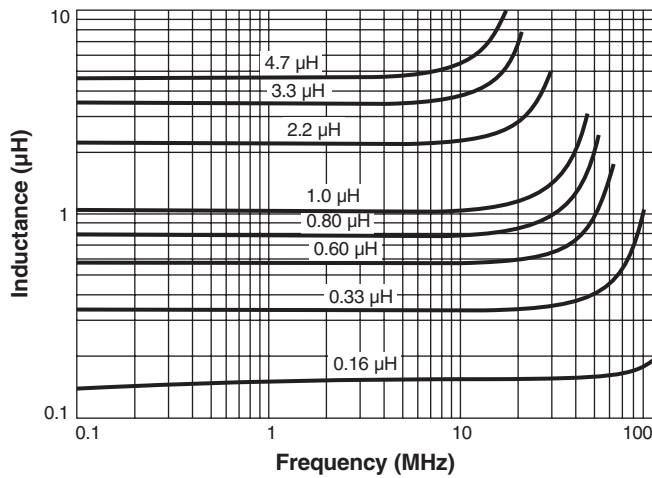
AE486PYA Series (5030)

L vs Current



AE486PYA Series (5030)

L vs Frequency



Suggested Land Pattern

Dash number	Terminal thickness (typ) (in / mm)
-161	0.0079 / 0.20
-331	0.0079 / 0.20
-601	0.0079 / 0.20
-801	0.0079 / 0.20
-102	0.0047 / 0.12
-222	0.0047 / 0.12
-332	0.0039 / 0.10
-472	0.0028 / 0.07

* Height dimension shown is for the mounted part after reflow. Dimension before mounting can be an additional 0.008 inch / 0.2 mm.

Dimensions are in $\frac{\text{inches}}{\text{mm}}$